

Features

- Ideal for printed circuit board
- Low forward voltage
- Low leakage current
- Ultrafast reverse recovery time
- High forward surge capability
- High temperature soldering:
260°C/10 seconds at terminals



DO-41

Mechanical Data

- **Case:**DO-41
- **Polarity:** Colour band denotes cathode end
- **Mounting position:** Any
- **Terminals:** Axial leads, solderable per MIL-STD-202,method 208 guaranteed

Major Ratings and Characteristics

$I_{F(AV)}$	1.0A
V_{RRM}	20V to 40V
I_{FSM}	30A
V_F	0.55V~0.95V
$T_J \text{ max.}$	125°C

Maximum Ratings & Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified

Single phase ,half wave, 60Hz,resistive or inductive load

For capacitive load, derate current by 20%.

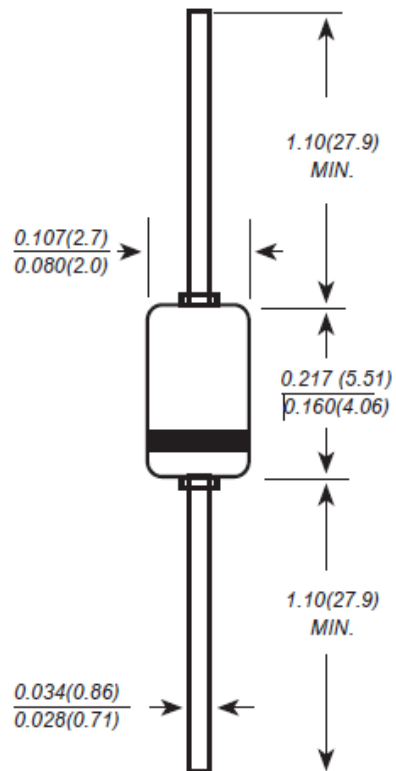
Items	Symbol	SR 120	SR 130	SR 140	SR 160	SR 180	SR 1100	SR 1150	SR 1200	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	60	80	100	150	200	V
Maximum average forward rectified current at $T_A=50^\circ\text{C}$	$I_{F(AV)}$	1.0								A
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load(JEDEC method)	I_{FSM}	30								A
Thermal resistance from junction to ambient	$R_{\theta JA}$	50								°C/W
Operating junction temperature range	T_J	-55 to +125								°C
Storage temperature range	T_{STG}	-55 to +125								°C

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Items	Test conditions		Symbol	SR 120	SR 130	SR 140	SR 160	SR 180	SR 1100	SR 1150	SR 1200	UNIT
Instantaneous forward voltage	I _F =1.0 A		V _F	0.55			0.70	0.85			0.95	V
Reverse current	V _{RRM}	T _J =25℃	I _R	0.5					0.2		mA	
		T _J =100℃		10			5		2			

Package Outline

DO-41



Dimensions in inches and (millimeters)